

# MJF47G

## High Voltage Power Transistor

### Isolated Package Applications

Designed for line operated audio output amplifiers, switching power supply drivers and other switching applications, where the mounting surface of the device is required to be electrically isolated from the heatsink or chassis.

#### Features

- Electrically Similar to the Popular TIP47
- 250 V<sub>CEO(sus)</sub>
- 1 A Rated Collector Current
- No Isolating Washers Required
- Reduced System Cost
- UL Recognized, File #E69369, to 3500 V<sub>RMS</sub> Isolation
- This is a Pb-Free Device\*

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	250	Vdc
Collector-Base Voltage	V <sub>CB</sub>	350	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5	Vdc
RMS Isolation Voltage (Note 1) Test No. 1 Per Figure 10 Test No. 2 Per Figure 11 Test No. 3 Per Figure 12 (for 1 sec, R.H. < 30%, T <sub>A</sub> = 25°C)	V <sub>ISOL</sub>	4500 3500 1500	V
Collector Current – Continuous – Peak	I <sub>C</sub>	1 2	Adc
Base Current – Continuous	I <sub>B</sub>	0.6	Adc
Total Power Dissipation (Note 2) @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	28.4 0.227	W W/°C
Total Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.0 0.016	W W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–65 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	°C/W
Thermal Resistance, Junction-to-Case (Note 2)	R <sub>θJC</sub>	4.4	°C/W
Lead Temperature for Soldering Purposes	T <sub>L</sub>	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Proper strike and creepage distance must be provided.
2. Measurement made with thermocouple contacting the bottom insulated surface (in a location beneath the die), the devices mounted on a heatsink with thermal grease and a mounting torque of  $\geq 6$  in. lbs.

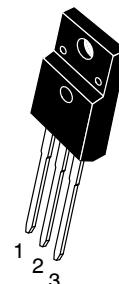
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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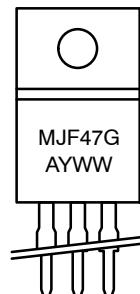
<http://onsemi.com>

NPN SILICON  
POWER TRANSISTOR  
1 AMPERE  
250 VOLTS, 28 WATTS



TO-220 FULLPACK  
CASE 221D  
STYLE 2

#### MARKING DIAGRAM



G = Pb-Free Package  
A = Assembly Location  
Y = Year  
WW = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping
MJF47G	TO-220 FULLPACK (Pb-Free)	50 Units/Rail

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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## ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Sustaining Voltage (Note 3) ( $I_C = 30 \text{ mA}_\text{dc}$ , $I_B = 0$ )	$V_{CEO(\text{sus})}$	250	—	Vdc
Collector Cutoff Current ( $V_{CE} = 150 \text{ Vdc}$ , $I_B = 0$ )	$I_{CEO}$	—	0.2	$\text{mA}_\text{dc}$
Collector Cutoff Current ( $V_{CE} = 350 \text{ Vdc}$ , $V_{BE} = 0$ )	$I_{CES}$	—	0.1	$\text{mA}_\text{dc}$
Emitter Cutoff Current ( $V_{BE} = 5 \text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	—	1	$\text{mA}_\text{dc}$
<b>ON CHARACTERISTICS (Note 3)</b>				
DC Current Gain ( $I_C = 0.3 \text{ Adc}$ , $V_{CE} = 10 \text{ Vdc}$ ) ( $I_C = 1 \text{ Adc}$ , $V_{CE} = 10 \text{ Vdc}$ )	$h_{FE}$	30 10	150 —	—
Collector-Emitter Saturation Voltage ( $I_C = 1 \text{ Adc}$ , $I_B = 0.2 \text{ Adc}$ )	$V_{CE(\text{sat})}$	—	1	Vdc
Base-Emitter On Voltage ( $I_C = 1 \text{ Adc}$ , $V_{CE} = 10 \text{ Vdc}$ )	$V_{BE(\text{on})}$	—	1.5	Vdc
<b>DYNAMIC CHARACTERISTICS</b>				
Current Gain – Bandwidth Product ( $I_C = 0.2 \text{ Adc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 2 \text{ MHz}$ )	$f_T$	10	—	MHz

3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

## TYPICAL CHARACTERISTICS

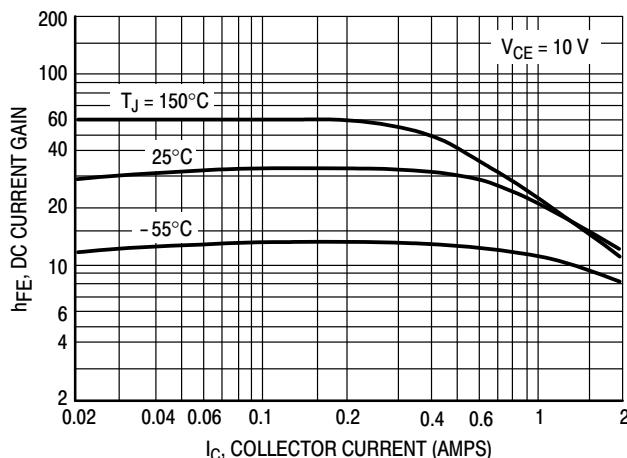


Figure 1. DC Current Gain

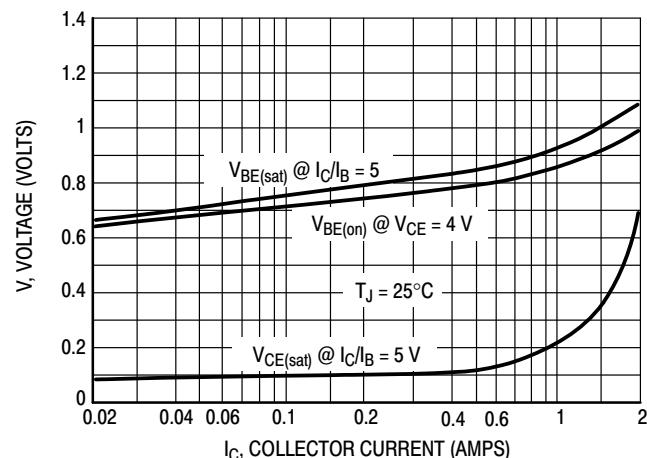
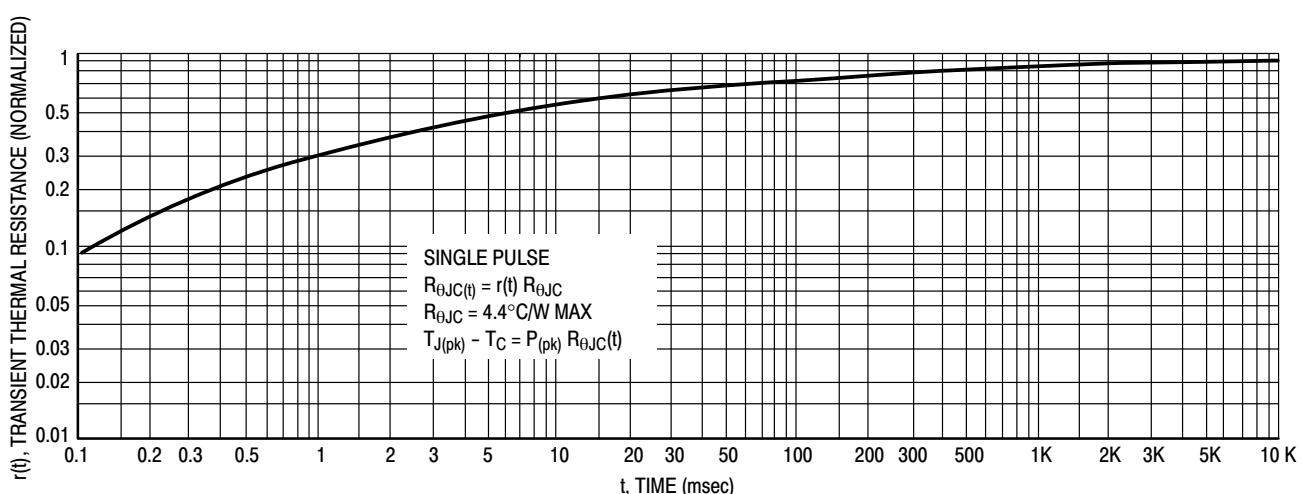
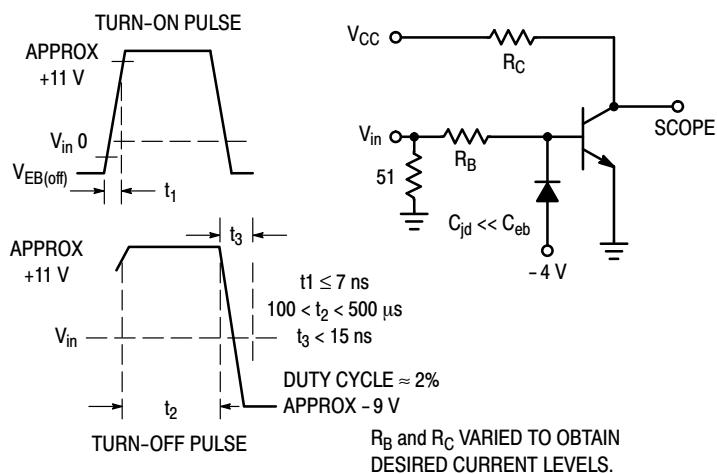
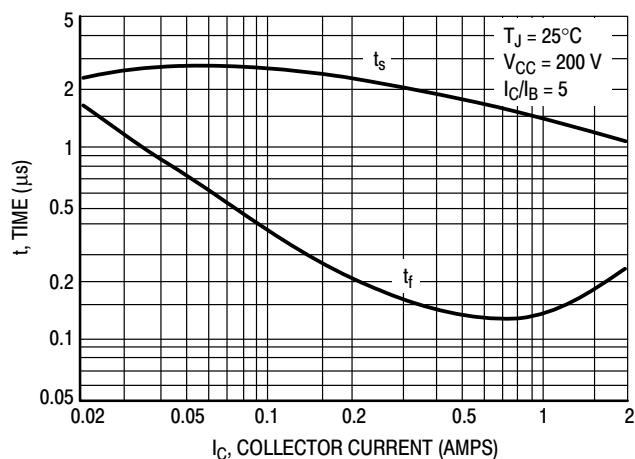
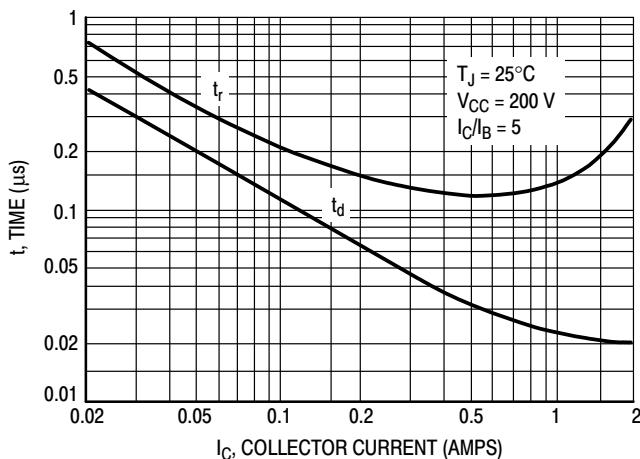
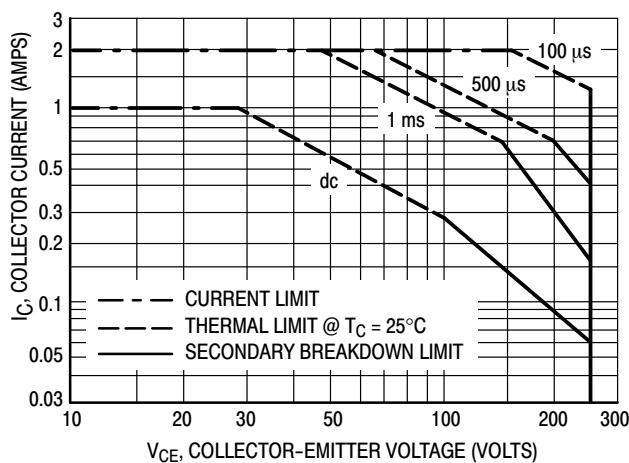


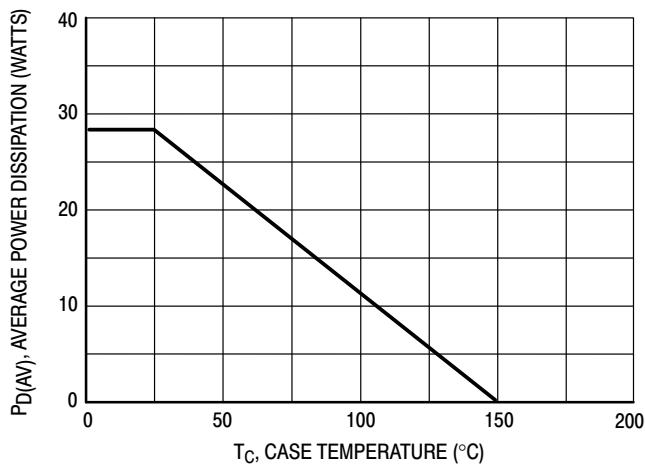
Figure 2. "On" Voltages

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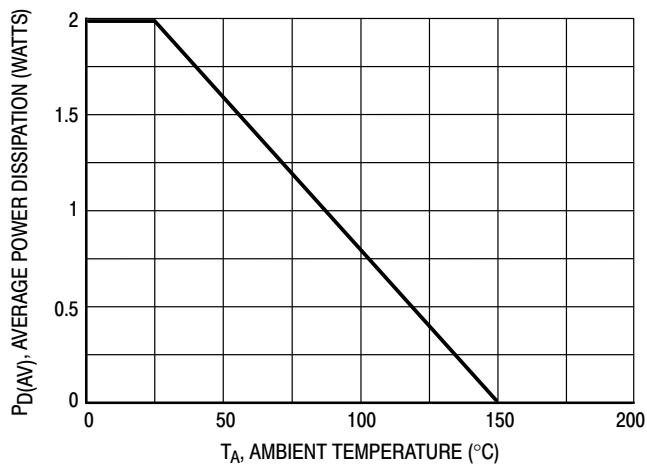
**Figure 7. Maximum Forward Bias Safe Operating Area**



**Figure 8. Power Derating**

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 7 is based on  $T_{J(pk)} = 150^\circ\text{C}$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^\circ\text{C}$ .  $T_{J(pk)}$  may be calculated from the data in Figure 6. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.



**Figure 9. Power Derating**

## TEST CONDITIONS FOR ISOLATION TESTS\*

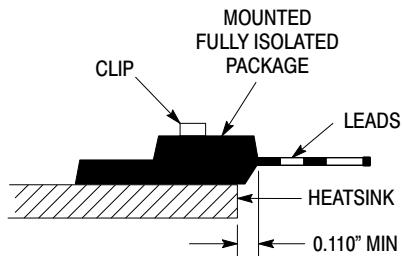


Figure 10. Clip Mounting Position  
for Isolation Test Number 1

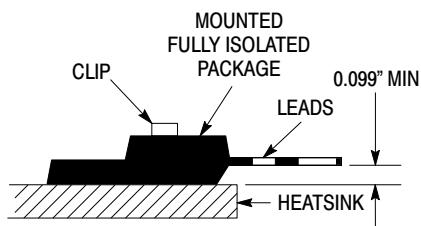


Figure 11. Clip Mounting Position  
for Isolation Test Number 2

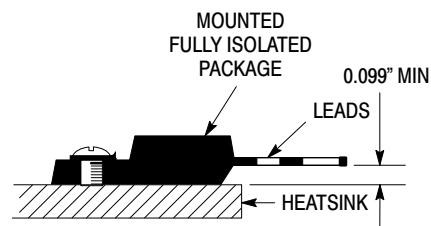


Figure 12. Screw Mounting Position  
for Isolation Test Number 3

\*Measurement made between leads and heatsink with all leads shorted together

## MOUNTING INFORMATION

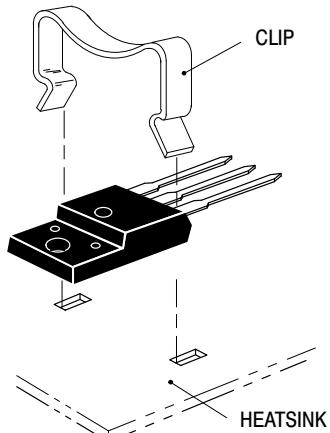
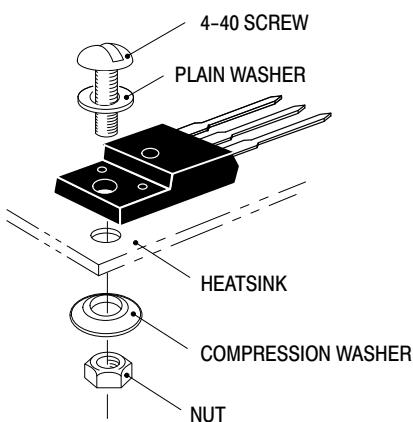


Figure 13. Typical Mounting Techniques\*

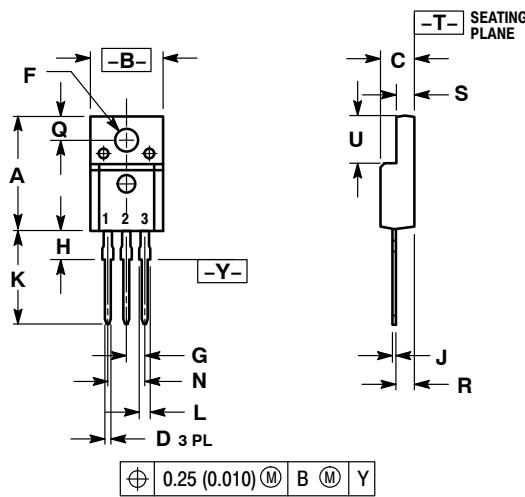
Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

\*\* For more information about mounting power semiconductors see Application Note AN1040.

## PACKAGE DIMENSIONS

TO-220 FULLPAK  
CASE 221D-03  
ISSUE K

NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH  
 3. 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.617	0.635	15.67	16.12
B	0.392	0.419	9.96	10.63
C	0.177	0.193	4.50	4.90
D	0.024	0.039	0.60	1.00
E	0.116	0.129	2.95	3.28
F	0.100	BSC	2.54	BSC
G	0.118	0.135	3.00	3.43
H	0.018	0.025	0.45	0.63
I	0.503	0.541	12.78	13.73
J	0.048	0.058	1.23	1.47
K	0.200	BSC	5.08	BSC
L	0.122	0.138	3.10	3.50
M	0.099	0.117	2.51	2.96
N	0.092	0.113	2.34	2.87
O	0.239	0.271	6.06	6.88

STYLE 2:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. Emitter

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